



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/551,843 Confirmation No. : 5817
First Named Inventor : Tadahiro OHMI
Filed : September 27, 2006
TC/A.U. : 2812
Examiner : Withers, Grant S.
Docket No. : 010986.56896US
Customer No. : 23911
Title : Semiconductor Device and Method for Manufacturing the
Same

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

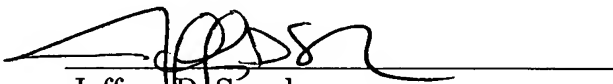
On the attached copy of the Official Corrected Filing Receipt, it was noted that the spelling of the first assignee's city was incorrect. Please make a change to reflect the correct city which is **—Miyagi, Japan—** instead of **Myagi, Japan**, as shown on the receipt. A copy of an originally filed Application Data Sheet is attached reflecting the same.

Kindly return the "Corrected" Official Filing Receipt to the undersigned attorney of record.

Please charge any additional fee or credit any overpayment to the Deposit Account of Crowell & Moring, L.L.P., Account No. 05-1323, Docket No.: 010986.56896US.

Respectfully submitted,

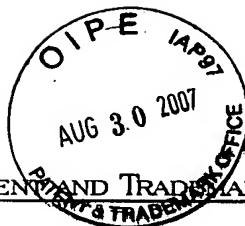
August 30, 2007


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APPL NO.	FILING OR 371(c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	TOT CLMS	IND CLMS
10/551,843	09/27/2006	2812	1030	010986.56896US	20	2

 23911
 CROWELL & MORING LLP
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 P.O. BOX 14300
 WASHINGTON, DC 20044-4300

CONFIRMATION NO. 5817

CORRECTED FILING RECEIPT



OC000000025062093

Date Mailed: 07/27/2007

Receipt is acknowledged of this nonprovisional patent application. The application will be taken up for examination in due course. Applicant will be notified as to the results of the examination. Any correspondence concerning the application must include the following identification information: the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. **If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).**

Applicant(s)

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Assignment For Published Patent Application

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Power of Attorney: The patent practitioners associated with Customer Number 23911.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/04700 03/31/2004

Foreign Applications

JAPAN 2003-100170 04/03/2003

DOCKETED

If Required, Foreign Filing License Granted: 11/17/2006

 The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/551,843**

Projected Publication Date: Not Applicable

Non-Publication Request: No

Early Publication Request: No

Title

Semiconductor device and method for manufacturing the same

Preliminary Class

438

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APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Number::	
Filing Date::	October 3, 2005
Application type::	Regular
Subject Matter::	Utility
Title::	Semiconductor Device and Method for Manufacturing the Same
Attorney Docket No.::	010986.56896US
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	1
Total Drawing Sheets::	5/showing Figs. 1-8
Small Entity?::	No
Petition included?::	No

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CORRESPONDENCE INFORMATION

Correspondence customer number:: 23911

REPRESENTATIVE INFORMATION

Representative customer number:: 23911

DOMESTIC PRIORITY INFORMATION

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application is a	National Stage of	PCT/JP2004/004700	March 31, 2004

FOREIGN PRIORITY INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed::
JP	2003-100170	04/03/2003	Yes

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